2SK1215

Silicon N-Channel MOS FET

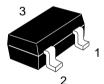
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Application

VHF amplifier

Outline

CMPAK



- 1. Gate
- 2. Drain
- 3. Source



2SK1215

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSX}^{*1}	20	V
Gate to source voltage	V _{GSS}	±5	V
Drain current	I _D	30	mA
Gate current	I _G	±1	mA
Channel power dissipation	Pch	100	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. $V_{GS} = -4 \text{ V}$

Electrical Characteristics ($Ta = 25^{\circ}C$)

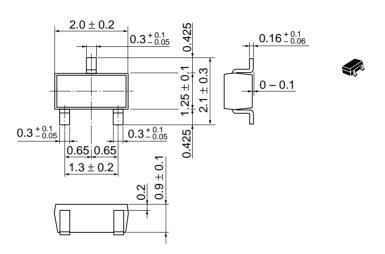
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSX}$	20	_	_	V	$I_D = 100 \ \mu\text{A}, \ V_{GS} = -4 \ V$
Gate cutoff current	I _{GSS}	_	_	±20	nA	$V_{GS} = \pm 5 \text{ V}, V_{DS} = 0$
Drain current	I _{DSS} *1	4	_	12	mA	V _{DS} = 10 V, V _{GS} = 0
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	0	_	-2.0	V	$V_{DS} = 10 \text{ V}, I_{D} = 10 \mu\text{A}$
Forward transfer admittance	y _{fs}	8	14	_	mS	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ kHz}$
Input capacitance	Ciss	_	2.5	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$
Output capacitance	Coss	_	1.6	_	pF	
Reverse transfer capacitance	Crss	_	0.03	_	pF	
Power gain	PG	24	_	_	dB	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$ f = 100 MHz
Noise figure	NF	_	_	3	dB	

Note: 1. The 2SK1215 is grouped by I_{DSS} as follows.

Grade	D	E	F
Mark	IGD	IGE	IGF
I _{DSS}	4 to 8	6 to 10	8 to 12

See characteristic curves of 2SK359.

Unit: mm



Hitachi Code	CMPAK
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.006 g

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